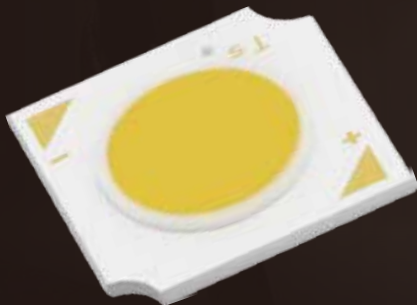


高密度集成式封装 High Density COB

- 提供客制化需求
- 高效率 (3000K, 118 lm/W)
- 高中心光强, 简易光学设计
- 提供3 step 单bin选择
- Customised service
- High efficacy (3000K, 118 lm/W)
- High CBCP, easy for optical design
- 3 step binning

LES6 / LES9 : 13.5 × 13.5 × 0.9 (mm)



Light Emitting Surface	Model Name	Power (W)	CCT (K)		CRI Min	Luminous Flux (lm)		Forward Voltage (V) Typ	Forward Current (mA)			
			2700	3000		Typ	Typ					
LES6	PB10H15	10	2700	3000	80	1215	1270	36.6	300			
			4000	5000		1330	1340					
			2700	3000		80	1865			1950	36.6	450
			4000	5000			2040			2060		
			2700	3000			80			2435		
4000	5000	2665	2690									
2700	3000	2665	2690									



Lextar.com

Sales.LT@Lextar.com

© Copyright Jun 2015 Lextar. All rights reserved. Information may change without notice.